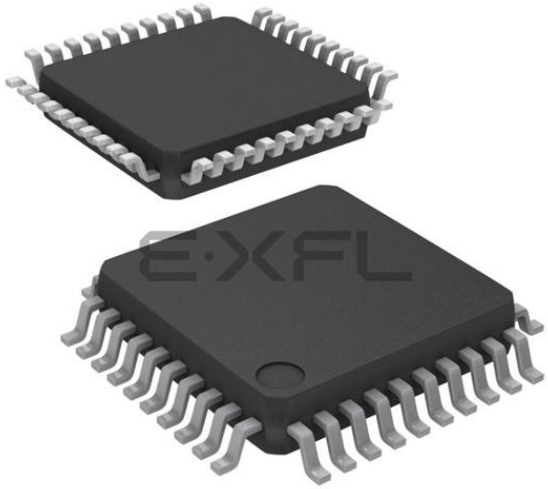
Renesas Electronics America Inc - R5F21122FP#U0 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	16MHz
Connectivity	SIO, UART/USART
Peripherals	LED, WDT
Number of I/O	22
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21122fp-u0

1. Overview

This MCU is built using the high-performance silicon gate CMOS process using a R8C Tiny Series CPU core and is packaged in a 32-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1M bytes of address space, it is capable of executing instructions at high speed.
The data flash ROM (2 KB X 2 blocks) is embedded.

1.1 Applications

Electric household appliance, office equipment, housing equipment (sensor, security), general industrial equipment, audio, etc.

1.2 Performance Overview

Table 1.1. lists the performance outline of this MCU.

Table 1.1 Performance outline

Item		Performance
CPU	Number of basic instructions	89 instructions
	Minimum instruction execution time	62.5 ns (f(XIN) = 16 MHz, VCC = 3.0 to 5.5 V) 100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
	Operating mode	Single-chip
	Address space	1M bytes
	Memory capacity	See Table 1.2 “Product List”
Peripheral function	Port	Input/Output: 22 (including LED drive port), Input: 2
	LED drive port	I/O port: 8
	Timer	Timer X: 8 bits x 1 channel, Timer Y: 8 bits x 1 channel, Timer Z: 8 bits x 1 channel (Each timer equipped with 8-bit prescaler) Timer C: 16 bits x 1 channel (Input capture circuit)
	Serial Interface	•1 channel Clock synchronous, UART •1 channel UART
	A/D converter	10-bit A/D converter: 1 circuit, 8 channels
	Watchdog timer	15 bits x 1 (with prescaler) Reset start function selectable
	Interrupt	Internal: 9 factors, External: 5 factors, Software: 4 factors, Priority level: 7 levels
	Clock generation circuit	2 circuits •Main clock generation circuit (Equipped with a built-in feedback resistor) •On-chip oscillator
	Oscillation stop detection function	Main clock oscillation stop detection function
Electrical characteristics	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 16 MHz) VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
	Power consumption	Typ.8mA (VCC = 5.0 V (f(XIN) = 16 MHz) Typ.5mA (VCC = 3.0 V, (f(XIN) = 10 MHz) Typ.35µA (VCC = 3.0 V, Wait mode, peripheral clock stops) Typ.0.7µA (VCC = 3.0 V, Stop mode)
Flash memory	Program/erase supply voltage	VCC = 2.7 to 5.5 V
	Program/erase endurance	10,000 times (Data flash)
		1,000 times (Program ROM)
Operating ambient temperature		-20 to 85 °C -40 to 85 °C (D-version)
Package		32-pin plastic mold LQFP

1.3 Block Diagram

Figure 1.1. shows this MCU block diagram.

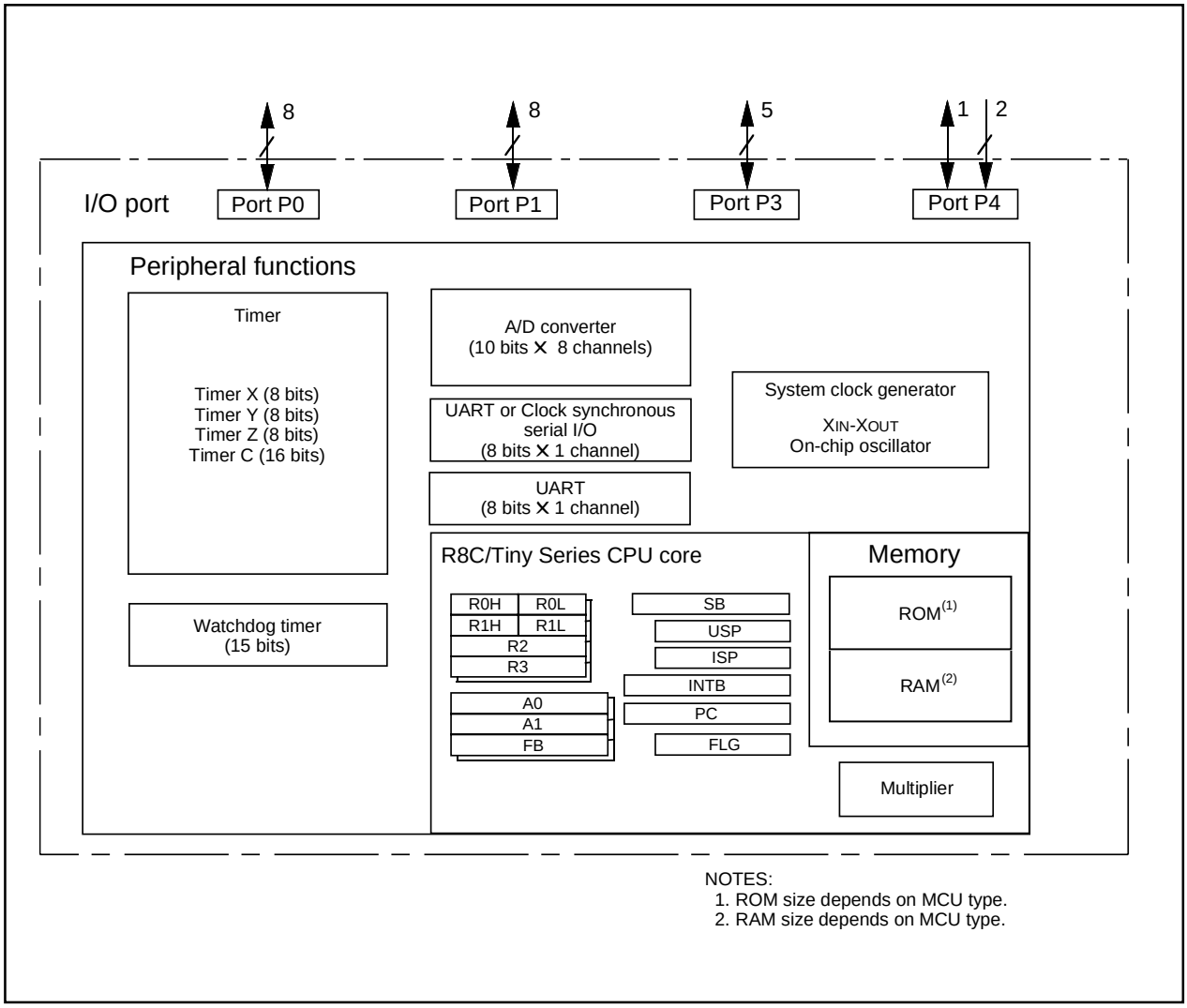
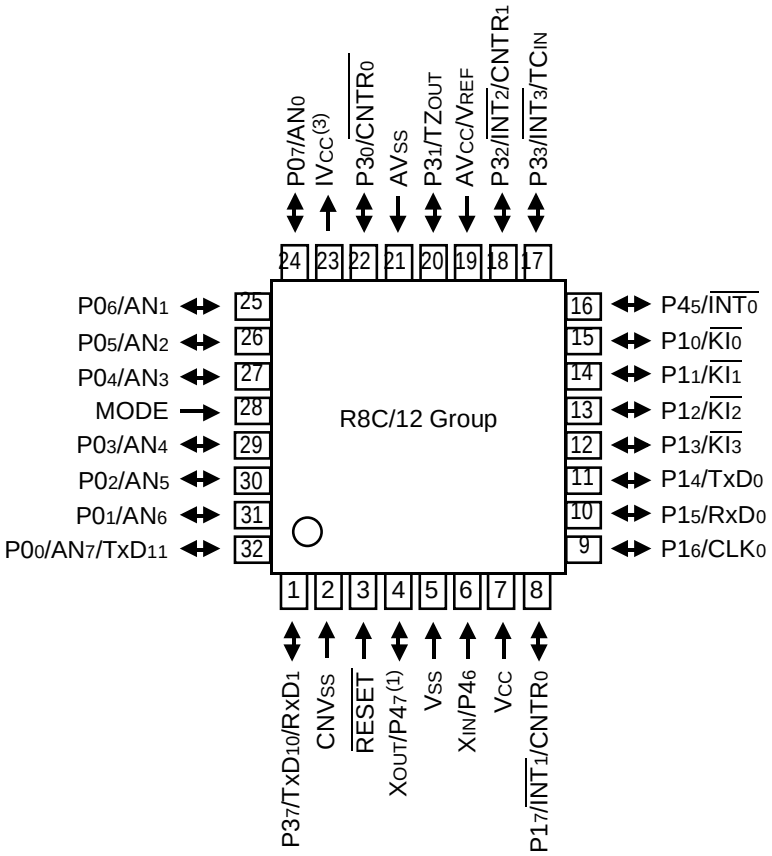


Figure 1.1 Block Diagram

1.5 Pin Assignments

Figure 1.3 shows the pin configuration (top view).

PIN CONFIGURATION (top view)



NOTES:
1. P47 functions only as an input port.
2. When using on-chip debugger, do not use P00/AN7/TxD11 and P37/TxD10/RxD1.
3. Do not connect IVcc to Vcc.

Package: PLQP0032GB-A (32P6U-A)

Figure 1.3 Pin Configuration (Top View)

1.6 Pin Description

Table 1.3 shows the pin description

Table 1.3 Pin description

Signal name	Pin name	I/O type	Function
Power supply input	Vcc, Vss	I	Apply 2.7 V to 5.5 V to the Vcc pin. Apply 0 V to the Vss pin.
IVcc	IVcc	O	This pin is to stabilize internal power supply. Connect this pin to Vss via a capacitor (0.1 µF). Do not connect to Vcc.
Analog power supply input	AVcc, AVss	I	Power supply input pins for A/D converter. Connect the AVcc pin to Vcc. Connect the AVss pin to Vss. Connect a capacitor between pins AVcc and AVss.
Reset input	$\overline{\text{RESET}}$	I	Input “L” on this pin resets the MCU.
CNVss	CNVss	I	Connect this pin to Vss via a resistor.
MODE	MODE	I	Connect this pin to Vcc via a resistor.
Main clock input	XIN	I	These pins are provided for the main clock generating circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an externally derived clock, input it to the XIN pin and leave the XOUT pin open.
Main clock output	XOUT	O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT}}_0$ to $\overline{\text{INT}}_3$	I	$\overline{\text{INT}}$ interrupt input pins.
Key input interrupt	$\overline{\text{KI}}_0$ to $\overline{\text{KI}}_3$	I	Key input interrupt pins.
Timer X	CNTR0	I/O	Timer X I/O pin
	$\overline{\text{CNTR}}_0$	O	Timer X output pin
Timer Y	CNTR1	I/O	Timer Y I/O pin
Timer Z	TZOUT	O	Timer Z output pin
Timer C	TCIN	I	Timer C input pin
Serial interface	CLK0	I/O	Transfer clock I/O pin.
	RxD0, RxD1	I	Serial data input pins.
	TxD0, TxD10, TxD11	O	Serial data output pins.
Reference voltage input	VREF	I	Reference voltage input pin for A/sD converter. Connect the VREF pin to Vcc.
A/D converter	AN0 to AN7	I	Analog input pins for A/D converter
I/O port	P00 to P07, P10 to P17, P30 to P33, P37, P45	I/O	These are 8-bit CMOS I/O ports. Each port has an input/output select direction register, allowing each pin in that port to be directed for input or output individually. Any port set to input can select whether to use a pull-up resistor or not by program. P10 to P17 also function as LED drive ports.
Input port	P46, P47	I	Port for input-only.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The CPU has 13 registers. Of these, R0, R1, R2, R3, A0, A1 and FB comprise a register bank. Two sets of register banks are provided.

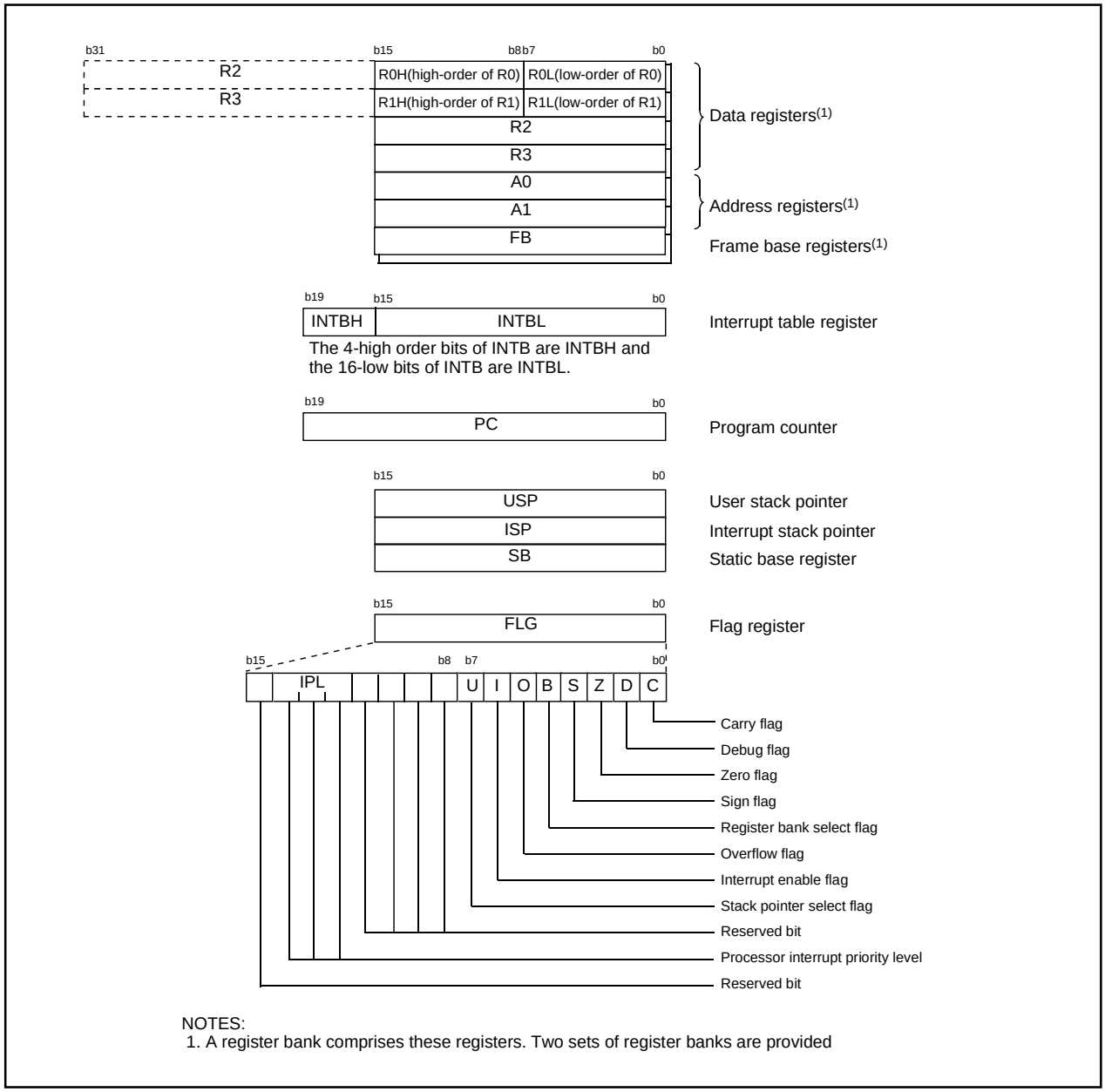


Figure 2.1 CPU Register

2.1 Data Registers (R0, R1, R2 and R3)

R0 is a 16-bit register for transfer, arithmetic and logic operations. The same applies to R1 to R3. The R0 can be split into high-order bit (R0H) and low-order bit (R0L) to be used separately as 8-bit data registers. The same applies to R1H and R1L as R0H and R0L. R2 can be combined with R0 to be used as a 32-bit data register (R2R0). The same applies to R3R1 as R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. They also are used for transfer, arithmetic and logic operations. The same applies to A1 as A0. A0 can be combined with A0 to be used as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC, 20 bits wide, indicates the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP and ISP, are 16 bits wide each. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is a 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic logic unit.

2.8.2 Debug Flag (D)

The D flag is for debug only. Set to “0”.

2.8.3 Zero Flag (Z)

The Z flag is set to “1” when an arithmetic operation resulted in 0; otherwise, “0”.

2.8.4 Sign Flag (S)

The S flag is set to “1” when an arithmetic operation resulted in a negative value; otherwise, “0”.

2.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is “0”. The register bank 1 is selected when this flag is set to “1”.

2.8.6 Overflow Flag (O)

The O flag is set to “1” when the operation resulted in an overflow; otherwise, “0”.

2.8.7 Interrupt Enable Flag (I)

The I flag enables a maskable interrupt.

An interrupt is disabled when the I flag is set to “0”, and are enabled when the I flag is set to “1”. The I flag is set to “0” when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to “0”, USP is selected when the U flag is set to “1”.

The U flag is set to “0” when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL, 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has greater priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

When write to this bit, set to “0”. When read, its content is indeterminate.

4. Special Function Register (SFR)

SFR(Special Function Register) is the control register of peripheral functions. Tables 4.1 to 4.4 list the SFR information

Table 4.1 SFR Information(1)(1)

Address	Register	Symbol	After reset
0000₁₆			
0001₁₆			
0002₁₆			
0003₁₆			
0004₁₆	Processor mode register 0	PM0	XXXX0X00₂
0005₁₆	Processor mode register 1	PM1	00XXX0X0₂
0006₁₆	System clock control register 0	CM0	01101000₂
0007₁₆	System clock control register 1	CM1	00100000₂
0008₁₆			
0009₁₆	Address match interrupt enable register	AIER	XXXXXX00₂
000A₁₆	Protect register	PRCR	00XXX000₂
000B₁₆			
000C₁₆	Oscillation stop detection register	OCD	00000100₂
000D₁₆	Watchdog timer reset register	WDTR	XX₁₆
000E₁₆	Watchdog timer start register	WDTS	XX₁₆
000F₁₆	Watchdog timer control register	WDC	00011111₂
0010₁₆ 0011₁₆ 0012₁₆	Address match interrupt register 0	RMAD0	00₁₆ 00₁₆ X0₁₆
0013₁₆			
0014₁₆ 0015₁₆ 0016₁₆	Address match interrupt register 1	RMAD1	00₁₆ 00₁₆ X0₁₆
0017₁₆			
0018₁₆			
0019₁₆			
001A₁₆			
001B₁₆			
001C₁₆			
001D₁₆			
001E₁₆	$\overline{\text{INT0}}$ input filter select register	INT0F	XXXXX000₂
001F₁₆			
0020₁₆			
0021₁₆			
0022₁₆			
0023₁₆			
0024₁₆			
0025₁₆			
0026₁₆			
0027₁₆			
0028₁₆			
0029₁₆			
002A₁₆			
002B₁₆			
002C₁₆			
002D₁₆			
002E₁₆			
002F₁₆			
0030₁₆			
0031₁₆			
0032₁₆			
0033₁₆			
0034₁₆			
0035₁₆			
0036₁₆			
0037₁₆			
0038₁₆			
0039₁₆			
003A₁₆			
003B₁₆			
003C₁₆			
003D₁₆			
003E₁₆			
003F₁₆			

NOTES :
1. Blank spaces are reserved. No access is allowed.

X : Undefined

Table 4.2 SFR Information(2)(1)

Address	Register	Symbol	After reset
0040₁₆			
0041₁₆			
0042₁₆			
0043₁₆			
0044₁₆			
0045₁₆			
0046₁₆			
0047₁₆			
0048₁₆			
0049₁₆			
004A₁₆			
004B₁₆			
004C₁₆			
004D₁₆	Key input interrupt control register	KUPIC	XXXXX000₂
004E₁₆	AD conversion interrupt control register	ADIC	XXXXX000₂
004F₁₆			
0050₁₆			
0051₁₆	UART0 transmit interrupt control register	S0TIC	XXXXX000₂
0052₁₆	UART0 receive interrupt control register	S0RIC	XXXXX000₂
0053₁₆	UART1 transmit interrupt control register	S1TIC	XXXXX000₂
0054₁₆	UART1 receive interrupt control register	S1RIC	XXXXX000₂
0055₁₆	$\overline{\text{INT2}}$ interrupt control register	INT2IC	XXXXX000₂
0056₁₆	Timer X interrupt control register	TXIC	XXXXX000₂
0057₁₆	Timer Y interrupt control register	TYIC	XXXXX000₂
0058₁₆	Timer Z interrupt control register	TZIC	XXXXX000₂
0059₁₆	$\overline{\text{INT1}}$ interrupt control register	INT1IC	XXXXX000₂
005A₁₆	$\overline{\text{INT3}}$ interrupt control register	INT3IC	XXXXX000₂
005B₁₆	Timer C interrupt control register	TCIC	XXXXX000₂
005C₁₆			
005D₁₆	$\overline{\text{INT0}}$ interrupt control register	INT0IC	XX00X000₂
005E₁₆			
005F₁₆			
0060₁₆			
0061₁₆			
0062₁₆			
0063₁₆			
0064₁₆			
0065₁₆			
0066₁₆			
0067₁₆			
0068₁₆			
0069₁₆			
006A₁₆			
006B₁₆			
006C₁₆			
006D₁₆			
006E₁₆			
006F₁₆			
0070₁₆			
0071₁₆			
0072₁₆			
0073₁₆			
0074₁₆			
0075₁₆			
0076₁₆			
0077₁₆			
0078₁₆			
0079₁₆			
007A₁₆			
007B₁₆			
007C₁₆			
007D₁₆			
007E₁₆			
007F₁₆			

NOTES :
1. Blank spaces are reserved. No access is allowed.

X : Undefined

Table 4.3 SFR Information(3)(1)

Address	Register	Symbol	After reset
0080₁₆	Timer Y, Z mode register	TYZMR	00₁₆
0081₁₆	Prescaler Y register	PREY	FF₁₆
0082₁₆	Timer Y secondary register	TYSC	FF₁₆
0083₁₆	Timer Y primary register	TYPR	FF₁₆
0084₁₆	Timer Y, Z waveform output control register	PUM	00₁₆
0085₁₆	Prescaler Z register	PREZ	FF₁₆
0086₁₆	Timer Z secondary register	TZSC	FF₁₆
0087₁₆	Timer Z primary register	TZPR	FF₁₆
0088₁₆			
0089₁₆			
008A₁₆	Timer Y, Z output control register	TYZOC	00₁₆
008B₁₆	Timer X mode register	TXMR	00₁₆
008C₁₆	Prescaler X register	PREX	FF₁₆
008D₁₆	Timer X register	TX	FF₁₆
008E₁₆	Timer count source setting register	TCSS	00₁₆
008F₁₆			
0090₁₆ 0091₁₆	Timer C register	TC	00₁₆ 00₁₆
0092₁₆			
0093₁₆			
0094₁₆			
0095₁₆			
0096₁₆	External input enable register	INTEN	00₁₆
0097₁₆			
0098₁₆	Key input enable register	KIEN	00₁₆
0099₁₆			
009A₁₆	Timer C control register 0	TCC0	00₁₆
009B₁₆	Timer C control register 1	TCC1	00₁₆
009C₁₆ 009D₁₆	Capture register	TM0	00₁₆ 00₁₆
009E₁₆			
009F₁₆			
00A0₁₆	UART0 transmit/receive mode register	U0MR	00₁₆
00A1₁₆	UART0 bit rate register	U0BRG	XX₁₆
00A2₁₆ 00A3₁₆	UART0 transmit buffer register	U0TB	XX₁₆ XX₁₆
00A4₁₆	UART0 transmit/receive control register 0	U0C0	00001000₂
00A5₁₆	UART0 transmit/receive control register 1	U0C1	00000010₂
00A6₁₆ 00A7₁₆	UART0 receive buffer register	U0RB	XX₁₆ XX₁₆
00A8₁₆	UART1 transmit/receive mode register	U1MR	00₁₆
00A9₁₆	UART1 bit rate generator	U1BRG	XX₁₆
00AA₁₆ 00AB₁₆	UART1 transmit buffer register	U1TB	XX₁₆ XX₁₆
00AC₁₆	UART1 transmit/receive control register 0	U1C0	00001000₂
00AD₁₆	UART1 transmit/receive control register 1	U1C1	00000010₂
00AE₁₆ 00AF₁₆	UART1 receive buffer register	U1RB	XX₁₆ XX₁₆
00B0₁₆	UART transmit/receive control register 2	UCON	00₁₆
00B1₁₆			
00B2₁₆			
00B3₁₆			
00B4₁₆			
00B5₁₆			
00B6₁₆			
00B7₁₆			
00B8₁₆			
00B9₁₆			
00BA₁₆			
00BB₁₆			
00BC₁₆			
00BD₁₆			
00BE₁₆			
00BF₁₆			

NOTES :
1. Blank spaces are reserved. No access is allowed.

X : Undefined

Table 4.4 SFR Information(4)(1)

Address	Register	Symbol	After reset
00C016 00C116	AD register	AD	XXXXXXXX2 XXXXXXXX2
00C216			
00C316			
00C416			
00C516			
00C616			
00C716			
00C816			
00C916			
00CA16			
00CB16			
00CC16			
00CD16			
00CE16			
00CF16			
00D016			
00D116			
00D216			
00D316			
00D416	AD control register 2	ADCON2	0016
00D516			
00D616	AD control register 0	ADCON0	00000XXX2
00D716	AD control register 1	ADCON1	0016
00D816			
00D916			
00DA16			
00DB16			
00DC16			
00DD16			
00DE16			
00DF16			
00E016	Port P0 register	P0	XX16
00E116	Port P1 register	P1	XX16
00E216	Port P0 direction register	PD0	0016
00E316	Port P1 direction register	PD1	0016
00E416			
00E516	Port P3 register	P3	XX16
00E616			
00E716	Port P3 direction register	PD3	0016
00E816	Port P4 register	P4	XX16
00E916			
00EA16	Port P4 direction register	PD4	0016
00EB16			
00EC16			
00ED16			
00EE16			
00EF16			
00F016			
00F116			
00F216			
00F316			
00F416			
00F516			
00F616			
00F716			
00F816			
00F916			
03FA16			
00FB16			
00FC16	Pull-up control register 0	PUR0	00XX00002
00FD16	Pull-up control register 1	PUR1	XXXXXX0X2
00FE16	Port P1 drive capacity control register	DRR	0016
00FF16			
≈			
01B316	Flash memory control register 4	FMR4	010000002
01B416			
01B516	Flash memory control register 1	FMR1	1000000X2
01B616			
01B716	Flash memory control register 0	FMR0	000000012
0FFFF16	Option function select register(2)	OFS	(Note 2)

NOTES :
1. Blank columns, 010016 to 01B216 and 01B816 to 02FF16 are all reserved. No access is allowed.
2. The watchdog timer control bit is assigned. Refer to "Figure11.2 OFS, WDC, WDTR and WDTS registers" for the OFS register details

X : Undefined

Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

Symbol	Parameter	Measuring condition	Standard			Unit
			Min.	Typ.	Max	
–	Program/Erase endurance(2)		1,000(3)	—	—	times
–	Byte program time		—	50	—	µs
–	Block erase time		—	0.4	—	s
td(SR-ES)	Time delay from Suspend Request until Erase Suspend		—	—	8	ms
–	Erase Suspend Request Interval		10	—	—	ms
–	Program, Erase Voltage		2.7	—	5.5	V
–	Read Voltage		2.7	—	5.5	V
–	Program, Erase Temperature		0	—	60	°C
–	Data hold time(7)	Ambient temperature = 55 °C	20	—	—	year

NOTES:
1. VCC=AVcc=2.7 to 5.5V at Topr = 0 to 60 °C, unless otherwise specified.
2. Definition of Program/Erase
   The endurance of Program/Erase shows a time for each block.
   If the program/erase number is “n” (n = 1,000, 10,000), “n” times erase can be performed for each block.
   For example, if performing one-byte write to the distinct addresses on Block A of 2K-byte block 2048 times and then erasing that block, the number of Program/Erase cycles is one time.
   However, performing multiple writes to the same address before an erase operation is prohibited (overwriting prohibited).
3. Numbers of Program/Erase cycles for which all electrical characteristics is guaranteed.
4. To reduce the number of Program/Erase cycles, a block erase should ideally be performed after writing in series as many distinct addresses (only one time each) as possible. If programming a set of 16 bytes, write up to 128 sets and then erase them one time. This will result in ideally reducing the number of Program/Erase cycles. Additionally, averaging the number of Program/Erase cycles for Block A and B will be more effective. It is important to track the total number of block erases and restrict the number.
5. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error disappears.
6. Customers desiring Program/Erase failure rate information should contact their Renesas technical support representative.
7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical Characteristics(4)

Symbol	Parameter	Measuring condition	Standard			Unit
			Min.	Typ.	Max	
–	Program/Erase endurance(2)		10000(3)	—	—	times
–	Byte program time(program/erase endurance ≤1000 times)		—	50	400	µs
–	Byte program time(program/erase endurance >1000 times)		—	65	—	µs
–	Block erase time(program/erase endurance ≤1000 times)		—	0.2	9	s
–	Block erase time(program/erase endurance >1000 times)		—	0.3	—	s
td(SR-ES)	Time delay from Suspend Request until Erase Suspend		—	—	8	ms
–	Erase Suspend Request Interval		10	—	—	ms
–	Program, Erase Voltage		2.7	—	5.5	V
–	Read Voltage		2.7	—	5.5	V
–	Program/Erase Temperature		-20(-40)(8)	—	85	°C
–	Data hold time(9)	Ambient temperature = 55 °C	20	—	—	year

NOTES:
1. Referenced to VCC=AVcc=2.7 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C unless otherwise specified.
2. Definition of Program/Erase
   The endurance of Program/Erase shows a time for each block.
   If the program/erase number is “n” (n = 1,000, 10,000), “n” times erase can be performed for each block.
   For example, if performing one-byte write to the distinct addresses on Block A of 2K-byte block 2048 times and then erasing that block, the number of Program/Erase cycles is one time.
   However, performing multiple writes to the same address before an erase operation is prohibited (overwriting prohibited).
3. Numbers of Program/Erase cycles for which all electrical characteristics is guaranteed.
4. Table 16.5 applies for Block A or B when the Program/Erase cycles are more than 1000. The byte program time up to 1000 cycles are the same as that of the program area (see Table 5.4).
5. To reduce the number of Program/Erase cycles, a block erase should ideally be performed after writing in series as many distinct addresses (only one time each) as possible. If programming a set of 16 bytes, write up to 128 sets and then erase them one time. This will result in ideally reducing the number of Program/Erase cycles. Additionally, averaging the number of Program/Erase cycles for Block A and B will be more effective. It is important to track the total number of block erases and restrict the number.
6. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error disappears.
7. Customers desiring Program/Erase failure rate information should contact their Renesas technical support representa-tive.
8. -40 °C for D version.
9. The data hold time includes time that the power supply is off or the clock is not supplied.

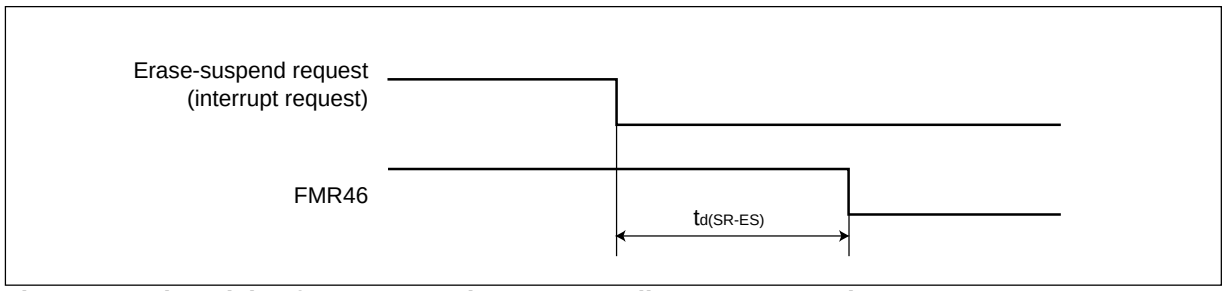


Figure 5.2 Time delay from Suspend Request until Erase Suspend

Table 5.6 Power Circuit Timing Characteristics

Symbol	Parameter	Measuring condition	Standard			Unit
			Min.	Typ.	Max.	
td(P-R)	Time for internal power supply stabilization during powering-on(2)		1	—	2000	µs
td(R-S)	STOP release time(3)		—	—	150	µs

NOTES:
1. The measuring condition is Vcc=AVcc=2.7 to 5.5 V and Topr=25 °C.
2. This shows the waiting time until the internal power supply generating circuit is stabilized during powering-on.
3. This shows the time until BCLK starts from the interrupt acknowledgement to cancel stop mode.

Table 5.7 Electrical Characteristics (1) [Vcc=5V]

Symbol	Parameter		Measuring condition		Standard Min.	Standard Typ.	Standard Max.	Unit
V_{OH}	"H" output voltage	Except X_{OUT}	I_{OH}=-5mA		Vcc-2.0	—	Vcc	V
			I_{OH}=-200µA		Vcc-0.3	—	Vcc	V
		X_{OUT}	Drive capacity HIGH	I_{OH}=-1 mA	Vcc-2.0	—	Vcc	V
			Drive capacity LOW	I_{OH}=-500µA	Vcc-2.0	—	Vcc	V
V_{OL}	"L" output voltage	Except P10 to P17, X_{OUT}	I_{OL}= 5 mA		—	—	2.0	V
			I_{OL}= 200 µA		—	—	0.45	V
		P10 to P17	Drive capacity HIGH	I_{OL}= 15 mA	—	—	2.0	V
			Drive capacity LOW	I_{OL}= 5 mA	—	—	2.0	V
			Drive capacity LOW	I_{OL}= 200 µA	—	—	0.45	V
		X_{OUT}	Drive capacity HIGH	I_{OL}= 1 mA	—	—	2.0	V
			Drive capacity LOW	I_{OL}=500 µA	—	—	2.0	V
V_{T+}-V_{T-}	Hysteresis	$\overline{INT0}$, $\overline{INT1}$, $\overline{INT2}$, $\overline{INT3}$, $\overline{KI0}$, $\overline{KI1}$, $\overline{KI2}$, $\overline{KI3}$, CNTRo, CNTR1, TCIN, RxD0, RxD1, P45			0.2	—	1.0	V
		$\overline{RESET}$			0.2	—	2.2	V
I_{IH}	"H" input current		V_I=5V		—	—	5.0	µA
I_{IL}	"L" input current		V_I=0V		—	—	-5.0	µA
R_{PULLUP}	Pull-up resistance		V_I=0V		30	50	167	kΩ
R_{fXIN}	Feedback resistance	X_{IN}			—	1.0	—	MΩ
f_{RING-S}	Low-speed on-chip oscillator frequency				40	125	250	kHz
V_{RAM}	RAM retention voltage		At stop mode		2.0	—	—	V

NOTES:
1. Referenced to Vcc = AVcc = 4.2 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, f(X_{IN})=20MHz unless otherwise specified.

Table 5.8 Electrical Characteristics (2) [Vcc=5V]

Symbol	Parameter		Measuring condition		Standard Min.	Standard Typ.	Standard Max.	Unit
I_{CC}	Power supply current (Vcc=3.3 to 5.5V) In single-chip mode, the output pins are open and other pins are Vss		High-speed mode	X_{IN}=16 MHz (square wave) On-chip oscillator on=125 kHz No division	—	8	14	mA
				X_{IN}=10 MHz (square wave) On-chip oscillator on=125 kHz No division	—	5	—	mA
			Medium-speed mode	X_{IN}=16 MHz (square wave) On-chip oscillator on=125 kHz Division by 8	—	3	—	mA
				X_{IN}=10 MHz (square wave) On-chip oscillator on=125 kHz Division by 8	—	2	—	mA
			On-chip oscillator mode	Main clock off On-chip oscillator on=125 kHz Division by 8	—	470	900	µA
			Wait mode	Main clock off On-chip oscillator on=125 kHz When a WAIT instruction is executed(1) Peripheral clock operation	—	40	80	µA
			Wait mode	Main clock off On-chip oscillator on=125 kHz When a WAIT instruction is executed(1) Peripheral clock off	—	38	76	µA
			Stop mode	Main clock off, Topr = 25 °C On-chip oscillator off CM10="1" Peripheral clock off	—	0.8	3.0	µA

NOTES:
1. Timer Y is operated with timer mode.
2. Referenced to Vcc = AVcc = 4.2 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, f(X_{IN})=20MHz unless otherwise specified.

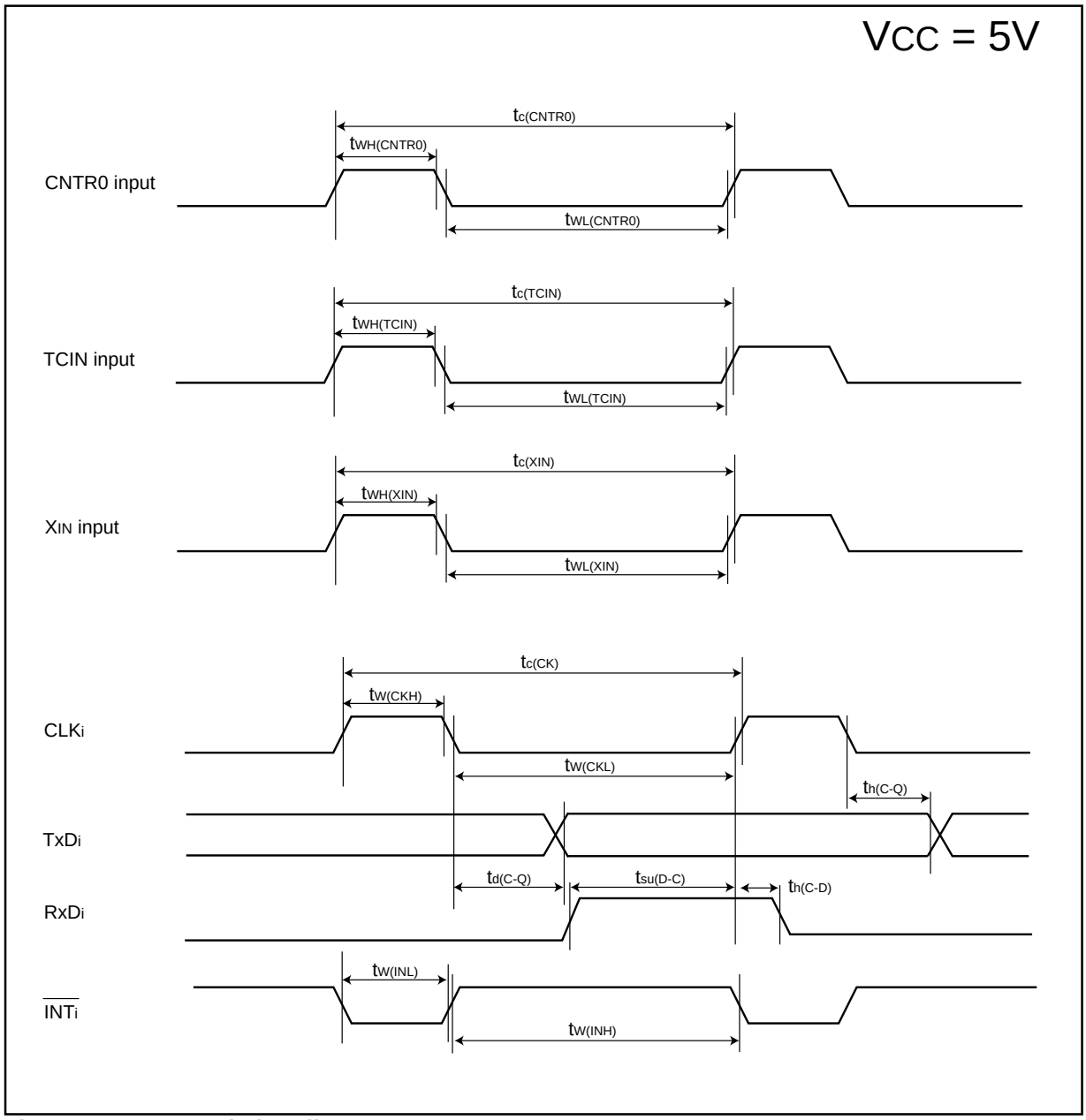


Figure 5.3 Vcc=5V timing diagram

Table 5.14 Electrical Characteristics (3) [Vcc=3V]

Symbol	Parameter		Measuring condition		Standard			Unit
					Min.	Typ.	Max.	
V_{OH}	"H" output voltage	Except X_{OUT}	I_{OH}=-1mA		V_{CC}-0.5	—	V_{CC}	V
		X_{OUT}	Drive capacity HIGH	I_{OH}=-0.1 mA	V_{CC}-0.5	—	V_{CC}	V
			Drive capacity LOW	I_{OH}=-50 µA	V_{CC}-0.5	—	V_{CC}	V
V_{OL}	"L" output voltage	Except P10 to P17, X_{OUT}	I_{OL}= 1 mA		—	—	0.5	V
		P10 to P17	Drive capacity HIGH	I_{OL}= 2 mA	—	—	0.5	V
			Drive capacity LOW	I_{OL}= 1 mA	—	—	0.5	V
		X_{OUT}	Drive capacity HIGH	I_{OL}= 0.1 mA	—	—	0.5	V
			Drive capacity LOW	I_{OL}=50 µA	—	—	0.5	V
V_{T+}-V_{T-}	Hysteresis	$\overline{INT0}$, $\overline{INT1}$, $\overline{INT2}$, $\overline{INT3}$, $\overline{KI0}$, $\overline{KI1}$, $\overline{KI2}$, KI3, CNTR0, CNTR1, TCIN, RxD0, RxD1, P45			0.2	—	0.8	V
		$\overline{RESET}$			0.2	—	1.8	V
I_{IH}	"H" input current		V_I=3V		—	—	4.0	µA
I_{IL}	"L" input current		V_I=0V		—	—	-4.0	µA
R_{PULLUP}	Pull-up resistance		V_I=0V		66	160	500	kΩ
R_{fXIN}	Feedback resistance	X_{IN}			—	3.0	—	MΩ
f_{RING}	On-chip oscillator frequency				40	125	250	kHz
V_{RAM}	RAM retention voltage		At stop mode		2.0	—	—	V

NOTES:
1. Referenced to V_{CC}=AV_{CC}=2.7 to 3.3V at Topr = -20 to 85 °C / -40 to 85 °C, f(X_{IN})=10MHz unless otherwise specified.

Table 5.15 Electrical Characteristics (4) [Vcc=3V]

Symbol	Parameter	Measuring condition		Standard			Unit
				Min.	Typ.	Max.	
I_{CC}	Power supply current (V_{CC1}=2.7 to 3.3V) In single-chip mode, the output pins are open and other pins are V_{SS}	High-speed mode	X_{IN}=16 MHz (square wave) On-chip oscillator on=125 kHz No division	—	7	12	mA
			X_{IN}=10 MHz (square wave) On-chip oscillator on=125 kHz No division	—	5	—	mA
		Medium-speed mode	X_{IN}=16 MHz (square wave) On-chip oscillator on=125 kHz Division by 8	—	2.5	—	mA
			X_{IN}=10 MHz (square wave) On-chip oscillator on=125 kHz Division by 8	—	1.6	—	mA
		On-chip oscillator mode	Main clock off On-chip oscillator on=125 kHz Division by 8	—	420	800	µA
		Wait mode	Main clock off On-chip oscillator on=125 kHz When a WAIT instruction is executed(1) Peripheral clock operation	—	37	74	µA
		Wait mode	Main clock off On-chip oscillator on=125 kHz When a WAIT instruction is executed(1) Peripheral clock off	—	35	70	µA
		Stop mode	Main clock off, Topr = 25 °C On-chip oscillator off CM10="1" Peripheral clock off	—	0.7	3.0	µA

NOTES:
1. Timer Y is operated with timer mode.
2. Referenced to V_{CC}=AV_{CC}=2.7 to 3.3V at Topr = -20 to 85 °C / -40 to 85 °C, f(X_{IN})=10MHz unless otherwise specified.

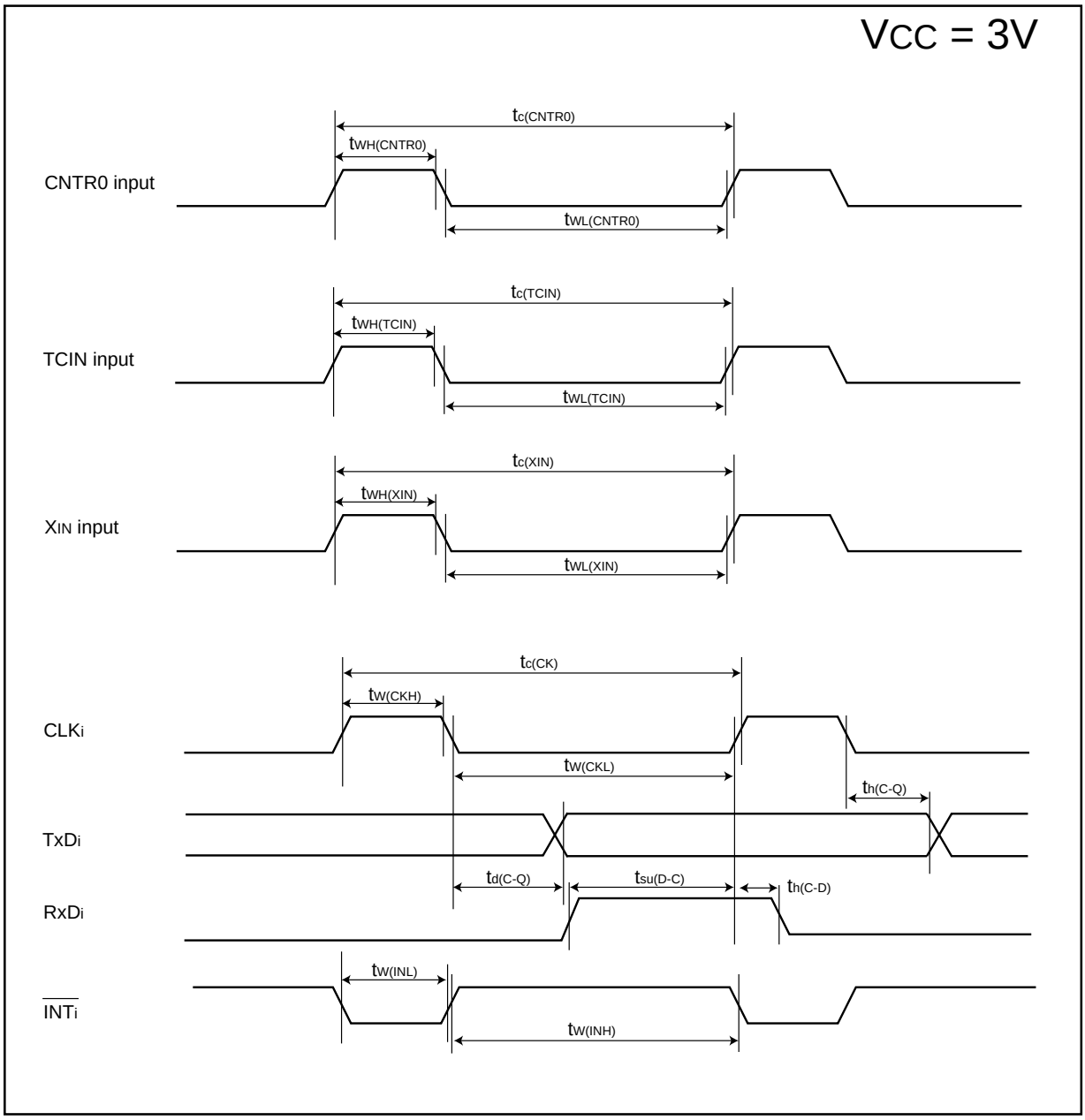


Figure 5.4 Vcc=3V timing diagram

Rev.	Date	Description	
		Page	Summary
1.20	Jan.27.2006	11	Table 4.2 SFR Information(2) NOTES:1 revised
		12	Table 4.3 SFR Information(3); 0081_{16}: “Prescaler Y” → “Prescaler Y Register” 0082_{16}: “Timer Y Secondary” → “Timer Y Secondary Register” 0083_{16}: “Timer Y Primary” → “Timer Y Primary Register” 0085_{16}: “Prescaler Z” → “Prescaler Z Register” 0086_{16}: “Timer Z Secondary” → “Timer Z Secondary Register” 0087_{16}: “Timer Z Primary” → “Timer Z Primary Register” $008C_{16}$: “Prescaler X” → “Prescaler X Register” revised NOTES:1 revised
		13	Table 4.4 SFR Information(4) NOTES:1 revised
		14	Table 5.2 Recommended Operating Conditions; NOTES: 1, 2, 3 revised
		15	Table 5.3 A/D Conversion Characteristics; “A/D operation clock frequency” → “A/D operating clock frequency” revised NOTES: 1, 2, 3, 4 revised
		16	Table 5.4 Flash Memory (Program ROM) Electrical Characteristics; “Data retention duration” → “Data hold time” revised “Topr” → “Ambient temperature” NOTES: 1 to 7 added Measuring condition of byte program time and block erase time deleted
		17	Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical characteristics “Data retention duration” → “Data hold time” revised “Topr” → “Ambient temperature” NOTES: 1, 3 revised, NOTES: 9 added Measuring condition of byte program time and block erase time deleted
		18	Table 5.7 Electrical Characteristics (1) [V_{CC}=5V]; “$P1_0$ to $P1_7$ Except X_{OUT}” → “Except $P1_0$ to $P1_7$, X_{OUT}” revised Table 5.8 Electrical Characteristics (2) [V_{CC}=5V]; Measuring condition Stop mode: “Topr = 25 °C” added NOTES: 1, 2 revised
		21	Table 5.14 Electrical Characteristics (3) [V_{CC}=3V] “$P1_0$ to $P1_7$ Except X_{OUT}” → “Except $P1_0$ to $P1_7$, X_{OUT}” revised
		22	Table 5.15 Electrical Characteristics (4) [V_{CC}=3V]; Measuring condition Stop mode: “Topr = 25 °C” added NOTES: 1, 2 revised

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